

A04817

30V Dual P-Channel MOSFET

General Description

The AO4817 uses advanced trench technology to provide excellent $R_{\rm DS(ON)},$ and ultra-low low gate charge with a 25V gate rating. This device is suitable for use as a load switch or in PWM applications. The device is ESD protected.

Product Summary

$$V_{DS}(V) = -30V$$

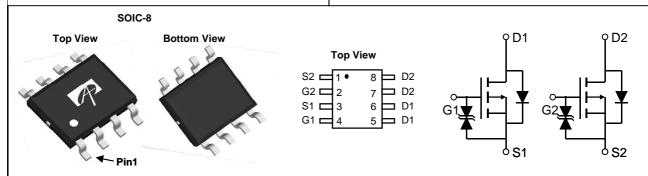
 $I_{D} = -8A(V_{GS} = -20V)$

$$\begin{split} R_{DS(ON)} < 18 m\Omega \; (V_{GS} = -20 V) \\ R_{DS(ON)} < 21 m\Omega \; (V_{GS} = -10 V) \end{split}$$

ESD Rating: 1.5KV HBM

100% UIS Tested 100% Rg tested





Absolute Maximum Ratings T _A =25℃ unless otherwise noted								
Parameter		Symbol	Maximum	Units				
Drain-Source Voltage		V_{DS}	-30	V				
Gate-Source Voltage		V_{GS}	±25	V				
Continuous Drain	T _A =25℃		-8					
Current ^A	T _A =70℃	I _D	-6.9	Α				
Pulsed Drain Current B		I _{DM}	-40					
	T _A =25℃	В	2	W				
Power Dissipation A	T _A =70℃	$-P_D$	1.44	VV				
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	${\mathfrak C}$				

Thermal Characteristics									
Parameter	Symbol	Тур	Max	Units					
Maximum Junction-to-Ambient A	t ≤ 10s	В	50	62.5	℃/W				
Maximum Junction-to-Ambient A	Steady-State	$R_{\theta JA}$	73	110	€\M				
Maximum Junction-to-Lead ^C	Steady-State	$R_{ heta JL}$	31	40	℃/W				

Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC F	PARAMETERS					
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-24V, V _{GS} =0V			-1	
		T _J =55	3.5 3.5		-5	μΑ
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±25V			±1	μΑ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=-250\mu A$	-1	-2.8	-3	V
$I_{D(ON)}$	On state drain current	V _{GS} =-10V, V _{DS} =-5V	-40			Α
		V _{GS} =-20V, I _D =-8A		14.1	18	mΩ
	Static Drain-Source On-Resistance	T _J =125	3.C	20	25	11122
		V _{GS} =-10V, I _D =-8A		17.1	21	mΩ
		V _{GS} =-4.5V, I _D =-4A		44		mΩ
g _{FS}	Forward Transconductance	V_{DS} =-5V, I_{D} =-8A		15		S
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V			-1	V
I _S	Maximum Body-Diode Continuous Current				-2.6	Α
DYNAMIC	PARAMETERS					
C _{iss}	Input Capacitance			1760	2200	pF
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =-15V, f=1MHz		360		pF
C _{rss}	Reverse Transfer Capacitance			255		pF
R_g	Gate resistance	$V_{GS}=0V$, $V_{DS}=0V$, $f=1MHz$		6.4	8	Ω
SWITCHI	NG PARAMETERS					
Q_g	Total Gate Charge			30	38	nC
Q_{gs}	Gate Source Charge	V_{GS} =-10V, V_{DS} =-15V, I_{D} =-8A		7		nC
Q_{gd}	Gate Drain Charge			8		nC
t _{D(on)}	Turn-On DelayTime			12.5		ns
t _r	Turn-On Rise Time	V _{GS} =-10V, V _{DS} =-15V, R _L =1.89	Ω,	10.5		ns
t _{D(off)}	Turn-Off DelayTime	$R_{GEN}=3\Omega$		40		ns
t _f	Turn-Off Fall Time			23		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-8A, dI/dt=100A/μs		24	30	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =-8A, dI/dt=100A/μs		16		nC

A: The value of R BLA is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with

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T_A=25° C. The value in any a given application depends on the user's specific board design. The current rating is based on the t 🔞 10s thermal resistance rating.

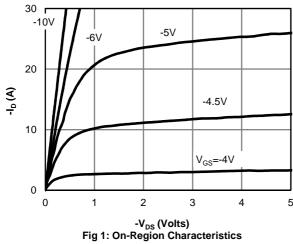
B: Repetitive rating, pulse width limited by junction temperature.

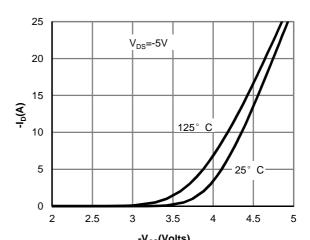
C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6,12,14 are obtained using $<300\,\mu s$ pulses, duty cycle 0.5% max.

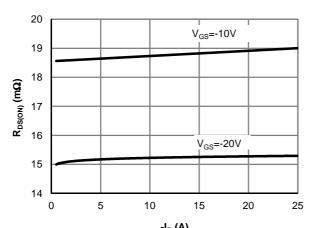
E. These tests are performed with the device mounted on 1 in ² FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

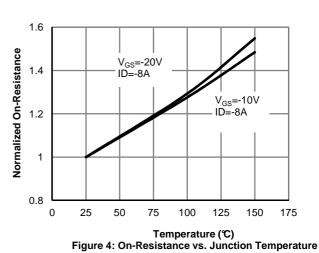


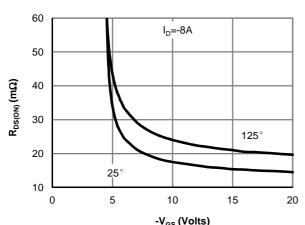


-V_{GS}(Volts) Figure 2: Transfer Characteristics

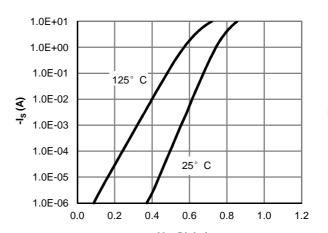


 ${\mbox{-I}_{\mbox{\scriptsize D}}}$ (A) Figure 3: On-Resistance vs. Drain Current and Gate Voltage



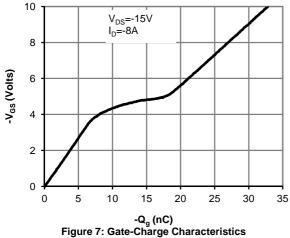


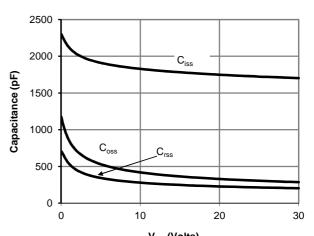
 $\hbox{-V}_{\rm GS} \, ({\rm Volts})$ Figure 5: On-Resistance vs. Gate-Source Voltage



-V_{SD} (Volts) Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





-V_{DS} (Volts)
Figure 8: Capacitance Characteristics

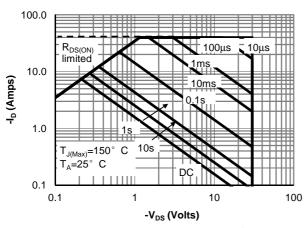
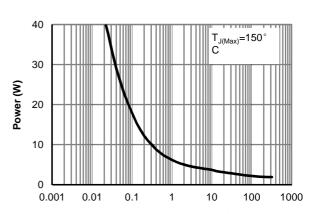


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)



Pulse Width (s) Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

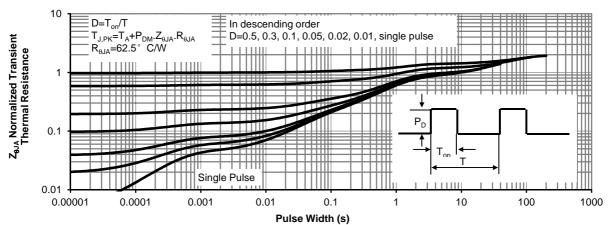


Figure 11: Normalized Maximum Transient Thermal Impedance